

# CD4066B Types

## CMOS Quad Bilateral Switch

For Transmission or Multiplexing of Analog or Digital Signals

High-Voltage Types (20-Volt Rating)

■ CD4066B is a quad bilateral switch intended for the transmission or multiplexing of analog or digital signals. It is pin-for-pin compatible with RCA-CD4016B, but exhibits a much lower on-state resistance. In addition, the on-state resistance is relatively constant over the full input-signal range.

The CD4066B consists of four independent bilateral switches. A single control signal is required per switch. Both the p and the n device in a given switch are biased on or off simultaneously by the control signal. As shown in Fig.1, the well of the n-channel device on each switch is either tied to the input when the switch is on or to  $V_{SS}$  when the switch is off. This configuration eliminates the variation of the switch-transistor threshold voltage with input signal, and thus keeps the on-state resistance low over the full operating-signal range.

The advantages over single-channel switches include peak input-signal voltage swings equal to the full supply voltage, and more constant on-state impedance over the input-signal range. For sample-and-hold applications, however, the CD4016B is recommended.

The CD4066B is available in 14-lead ceramic dual-in-line packages (D and F suffixes), 14-lead plastic dual-in-line packages (E suffix), 14-lead small-outline package (NSR suffix), and in chip form (H suffix).

### MAXIMUM RATINGS, Absolute-Maximum Values:

DC SUPPLY-VOLTAGE RANGE, ( $V_{DD}$ )	.....	-0.5V to +20V
Voltages referenced to $V_{SS}$ Terminal)	.....	
INPUT VOLTAGE RANGE, ALL INPUTS	.....	-0.5V to $V_{DD} + 0.5V$
DC INPUT CURRENT, ANY ONE INPUT	.....	$\pm 10mA$
POWER DISSIPATION PER PACKAGE ( $P_D$ ):	.....	
For $T_A = -55^\circ C$ to $+100^\circ C$	.....	500mW
For $T_A = +100^\circ C$ to $+125^\circ C$	.....	Derate Linearly at 12mW/ $^\circ C$ to 200mW
DEVICE DISSIPATION PER OUTPUT TRANSISTOR	.....	
FOR $T_A =$ FULL PACKAGE-TEMPERATURE RANGE (All Package Types)	.....	100mW
OPERATING-TEMPERATURE RANGE ( $T_A$ )	.....	$-55^\circ C$ to $+125^\circ C$
STORAGE TEMPERATURE RANGE ( $T_{stg}$ )	.....	$-65^\circ C$ to $+150^\circ C$
LEAD TEMPERATURE (DURING SOLDERING):	.....	
At distance 1/16 $\pm$ 1/32 inch (1.59 $\pm$ 0.79mm) from case for 10s max	.....	$+265^\circ C$

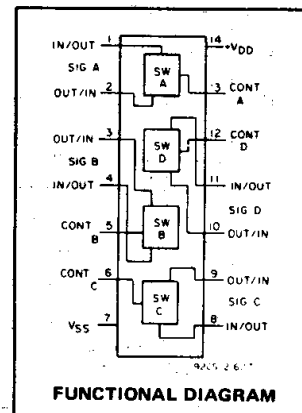
### RECOMMENDED OPERATING CONDITIONS

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

CHARACTERISTIC	LIMITS		UNITS
	Min.	Max.	
Supply-Voltage Range (For $T_A =$ Full Package-Temperature Range)	3	18	V

### Features:

- 15-V digital or  $\pm 7.5$ -V peak-to-peak switching
- 125 $\Omega$  typical on-state resistance for 15-V operation
- Switch on-state resistance matched to within 5  $\Omega$  over 15-V signal-input range
- On-state resistance flat over full peak-to-peak signal range
- High on/off output-voltage ratio: 80 dB typ. @  $f_{is} = 10$  kHz,  $R_L = 1$  k $\Omega$
- High degree of linearity: <0.5% distortion typ. @  $f_{is} = 1$  kHz,  $V_{is} = 5$  Vp-p,  $V_{DD} - V_{SS} \geq 10$  V,  $R_L = 10$  k $\Omega$
- Extremely low off-state switch leakage resulting in very low offset current and high effective off-state resistance: 10 pA typ. @  $V_{DD} - V_{SS} = 10$  V,  $T_A = 25^\circ C$
- Extremely high control input impedance (control circuit isolated from signal circuit):  $10^{12} \Omega$  typ.
- Low crosstalk between switches: -50 dB typ. @  $f_{is} = 8$  MHz,  $R_L = 1$  k $\Omega$
- Matched control-input to signal-output capacitance: Reduces output signal transients
- Frequency response, switch on = 40 MHz (typ.)
- 100% tested for quiescent current at 20 V
- 5-V, 10-V, and 15-V parametric ratings
- Meets all requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Description of "B" Series CMOS Devices"



### Applications:

- Analog signal switching/multiplexing
- Signal gating
- Modulator
- Squelch control
- Demodulator
- Chopper
- Commutating switch
- Digital signal switching/Multiplexing
- Transmission-gate logic implementation
- Analog-to-digital & digital-to-analog conversion
- Digital control of frequency, impedance, phase, and analog-signal gain

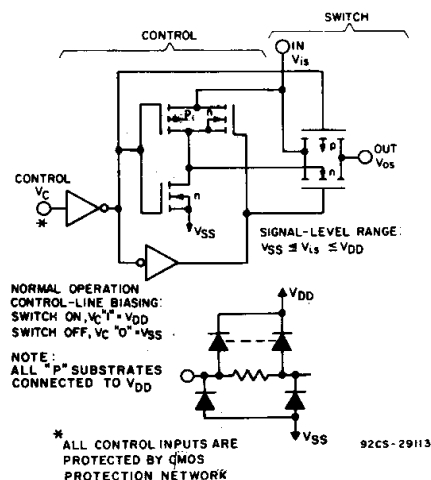


Fig. 1 – Schematic diagram of 1 of 4 identical switches and its associated control circuitry.

# CD4066B Types

## ELECTRICAL CHARACTERISTICS

CHARACTERISTIC	TEST CONDITIONS	LIMITS AT INDICATED TEMPERATURES (°C)								UNITS
		V <sub>IN</sub> (V)	V <sub>DD</sub> (V)	+25						
				-55	-40	+85	+125	Typ.	Max.	
Quiescent Device Current, I <sub>DD</sub>		0,5	5	0.25	0.25	7.5	7.5	0.01	0.25	μA
		0,10	10	0.5	0.5	15	15	0.01	0.5	
		0,15	15	1	1	30	30	0.01	1	
		0,20	20	5	5	150	150	0.02	5	
Signal Inputs (V <sub>is</sub> ) and Output (V <sub>os</sub> )										
On-State Resistance, r <sub>on</sub> Max.	V <sub>C</sub> = V <sub>DD</sub> R <sub>L</sub> = 10 kΩ returned to V <sub>DD</sub> - V <sub>SS</sub> 2 V <sub>is</sub> = V <sub>SS</sub> to V <sub>DD</sub>	5	800	850	1200	1300	470	1050	Ω	
		10	310	330	500	550	180	400		
		15	200	210	300	320	125	240		
ΔOn-State Resistance Between Any 2 Switches, Δr <sub>on</sub>	R <sub>L</sub> = 10 kΩ, V <sub>C</sub> = V <sub>DD</sub>	5	-	-	-	-	15	-	Ω	
		10	-	-	-	-	10	-		
		15	-	-	-	-	5	-		
Total Harmonic Distortion, THD	V <sub>C</sub> = V <sub>DD</sub> = 5 V, V <sub>SS</sub> = -5 V, V <sub>is</sub> (p-p) = 5 V (Sine wave centered on 0 V) R <sub>L</sub> = 10 kΩ, f <sub>is</sub> = 1 kHz sine wave		-	-	-	-	0.4	-	%	
-3dB Cutoff Frequency (Switch on)	V <sub>C</sub> = V <sub>DD</sub> = 5 V, V <sub>SS</sub> = -5 V, V <sub>is</sub> (p-p) = 5 V (Sine wave centered on 0 V) R <sub>L</sub> = 1 kΩ,		-	-	-	-	40	-	MHz	
-50dB Feed-through Frequency (Switch off)	V <sub>C</sub> = V <sub>SS</sub> = -5 V, V <sub>is</sub> (p-p) = 5 V Sine wave centered on 0 V R <sub>L</sub> = 1 kΩ		-	-	-	-	1	-	MHz	
Input/Output Leakage Current (Switch off) I <sub>is</sub> Max.	V <sub>C</sub> = 0 V V <sub>is</sub> = 18 V; V <sub>os</sub> = 0 V, V <sub>is</sub> = 0 V; V <sub>os</sub> = 18 V	18	±0.1	±0.1	±1	±1	±10 <sup>-5</sup>	±0.1	μA	
-50 dB Crosstalk Frequency	V <sub>C</sub> (A) = V <sub>DD</sub> = +5 V, V <sub>C</sub> (B) = V <sub>SS</sub> = -5 V, V <sub>is</sub> (A) = 5 V <sub>p-p</sub> , 50 Ω source R <sub>L</sub> = 1 kΩ		-	-	-	-	8	-	MHz	
Propagation Delay (Signal Input to Signal Output) t <sub>pd</sub>	R <sub>L</sub> = 200 kΩ V <sub>C</sub> = V <sub>DD</sub> , V <sub>SS</sub> = GND, C <sub>L</sub> = 50 pF V <sub>is</sub> = 10 V (Square wave centered on 5 V t <sub>r</sub> , t <sub>f</sub> = 20 ns	5	-	-	-	-	20	40	ns	
		10	-	-	-	-	10	20		
		15	-	-	-	-	7	15		
Capacitance: Input, C <sub>is</sub>	V <sub>DD</sub> = +5 V V <sub>C</sub> = V <sub>SS</sub> = -5 V		-	-	-	-	8	-	pF	
Output, C <sub>os</sub>			-	-	-	-	8	-		
Feedthrough, C <sub>ios</sub>			-	-	-	-	0.5	-		

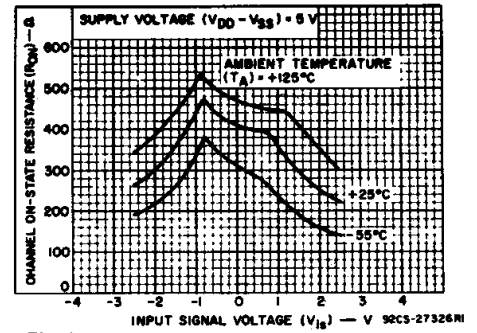


Fig. 2— Typical on-state resistance vs. input signal voltage (all types).

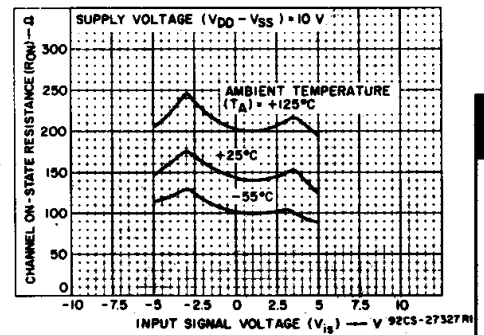


Fig. 3— Typical on-state vs. input signal voltage (all types).

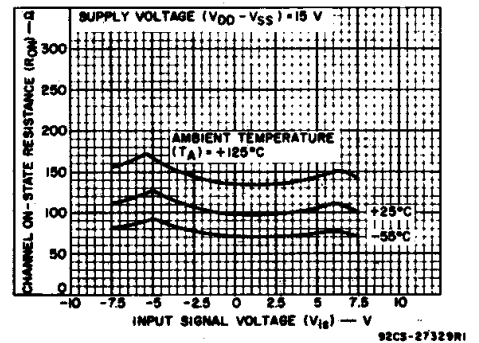


Fig. 4— Typical on-state resistance vs. input signal voltage (all types).

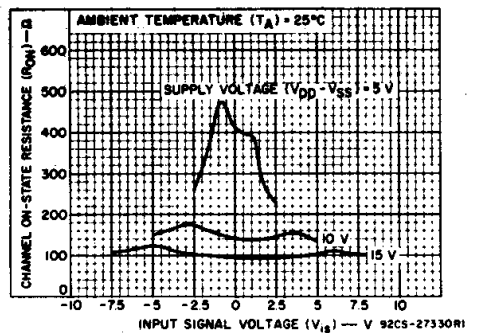


Fig. 5— on-state resistance vs. input signal voltage (all types).

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COMMERCIAL CMOS  
HIGH VOLTAGE ICs

# CD4066B Types

## ELECTRICAL CHARACTERISTICS (cont'd)

CHARACTERISTIC	TEST CONDITIONS	LIMITS AT INDICATED TEMPERATURES (°C)						UNITS	
		V <sub>DD</sub> (V)	+25						
			-55	-40	+85	+125	Typ.		Max.
Control (V <sub>C</sub> )									
Control Input Low Voltage, V <sub>ILC</sub> Max.	I <sub>is</sub>   < 10 μA V <sub>is</sub> = V <sub>SS</sub> , V <sub>OS</sub> = V <sub>DD</sub> and V <sub>is</sub> = V <sub>DD</sub> , V <sub>OS</sub> = V <sub>SS</sub>	5	1	1	1	1	-	1	V
		10	2	2	2	2	-	2	
		15	2	2	2	2	-	2	
Control Input High Voltage, V <sub>IHC</sub>	See Fig. 6	5	3.5 (Min.)						V
		10	7 (Min.)						
		15	11 (Min.)						
Input Current, I <sub>IN</sub> Max.	V <sub>is</sub> ≤ V <sub>DD</sub> V <sub>DD</sub> - V <sub>SS</sub> = 18 V V <sub>CC</sub> ≤ V <sub>DD</sub> - V <sub>SS</sub>	18	±0.1	±0.1	±1	±1	±10 <sup>-5</sup>	±0.1	μA
Crosstalk (Control Input to Signal Output)	V <sub>C</sub> = 10 V (Sq. Wave) t <sub>r</sub> , t <sub>f</sub> = 20 ns R <sub>L</sub> = 10 kΩ	10	-	-	-	-	50	-	mV
Turn-On and Turn-Off Propagation Delay	V <sub>IN</sub> = V <sub>DD</sub> t <sub>r</sub> , t <sub>f</sub> = 20 ns C <sub>L</sub> = 50 pF R <sub>L</sub> = 1 kΩ	5	-	-	-	-	35	70	ns
		10	-	-	-	-	20	40	
		15	-	-	-	-	15	30	
Maximum Control Input Repetition Rate	V <sub>is</sub> = V <sub>DD</sub> , V <sub>SS</sub> = GND, R <sub>L</sub> = 1 kΩ to gnd, C <sub>L</sub> = 50 pF, V <sub>C</sub> = 10 V (Square wave centered on 5 V) t <sub>r</sub> , t <sub>f</sub> = 20 ns, V <sub>os</sub> = ½ V <sub>os</sub> @ 1 kHz	5	-	-	-	-	6	-	MHz
		10	-	-	-	-	9	-	
		15	-	-	-	-	9.5	-	
Input Capacitance, C <sub>IN</sub>			-	-	-	-	5	7.5	pF

V <sub>DD</sub> (V)	V <sub>is</sub> (V)	Switch Input I <sub>is</sub> (mA)					Switch Output, V <sub>os</sub> (V)	
		-55°C	-40°C	+25°C	+85°C	+125°C	Min.	Max.
5	0	0.64	0.61	0.51	0.42	0.36	-	0.4
5	5	-0.64	-0.61	-0.51	-0.42	-0.36	4.6	-
10	0	1.6	1.5	1.3	1.1	0.9	-	0.5
10	10	-1.6	-1.5	-1.3	-1.1	-0.9	9.5	-
15	0	4.2	4	3.4	2.8	2.4	-	1.5
15	15	-4.2	-4	-3.4	-2.8	-2.4	13.5	-

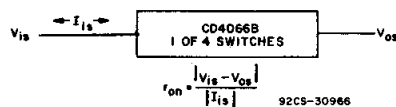


Fig. 6— Determination of  $r_{on}$  as a test condition for control input high voltage (V<sub>IHC</sub>) specification.

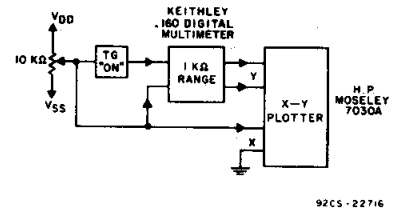


Fig. 7 — Channel on-state resistance measurement circuit.

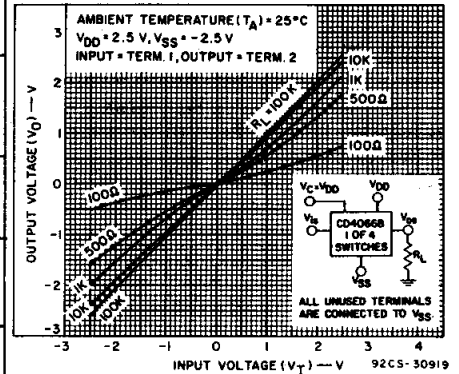


Fig. 8—Typical ON characteristics for 1 of 4 Channels.

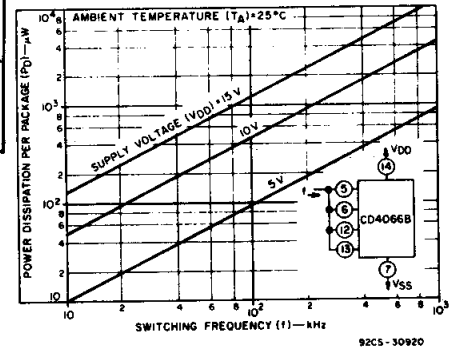


Fig. 9 — Power dissipation per package vs. switching frequency.

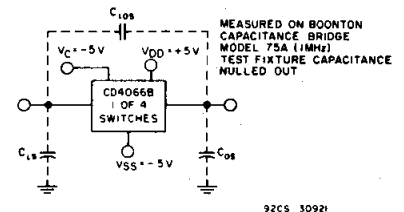


Fig. 10 — Capacitance test circuit.

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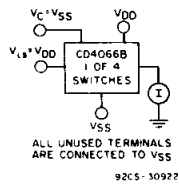


Fig. 11 - Off-switch input or output leakage.

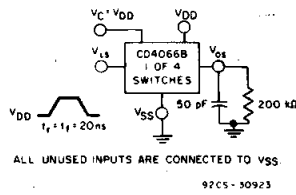


Fig. 12 - Propagation delay time signal input ( $V_{Is}$ ) to signal output ( $V_{Os}$ ).

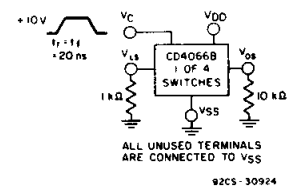


Fig. 13 - Crosstalk-control input to signal output.

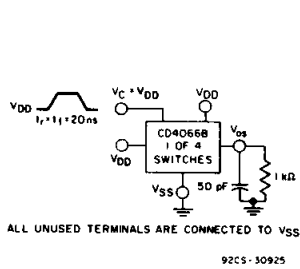


Fig. 14 - Propagation delay  $t_{PLH}$ ,  $t_{PHL}$  control-signal output. Delay is measured at  $V_{Os}$  level of +10% from ground (turn-on) or on-state output level (turn-off).

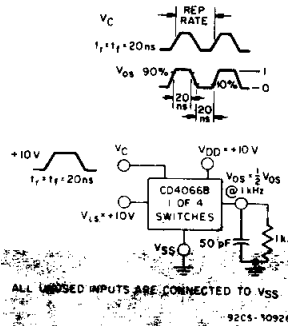


Fig. 15 - Maximum allowable control input repetition rate.

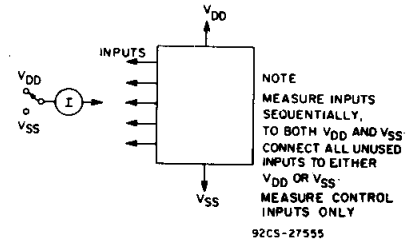


Fig. 16 - Input leakage current test circuit.

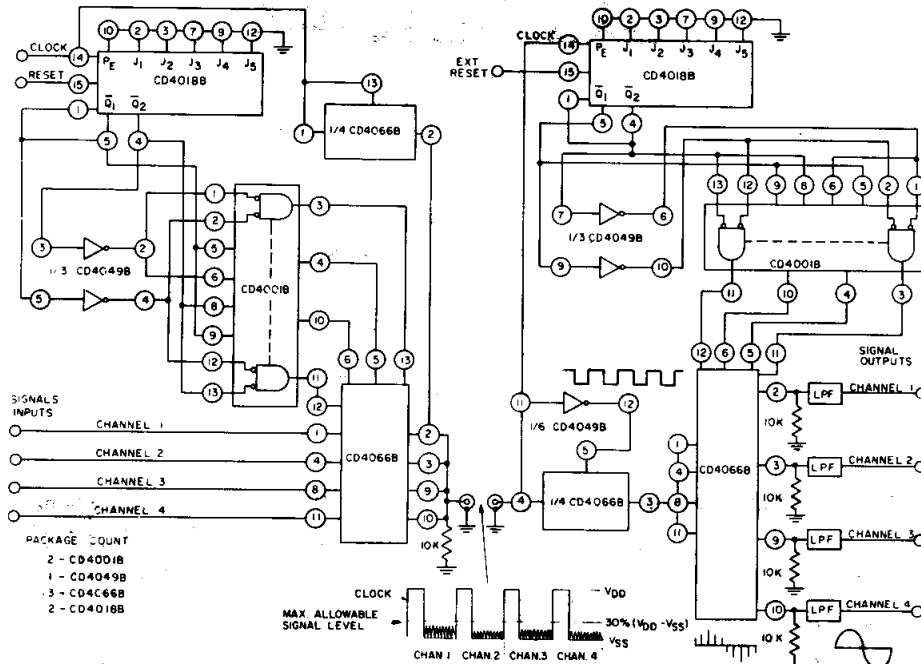


Fig. 17 - 4-channel PAM multiplex system diagram.

## CD4066B Types

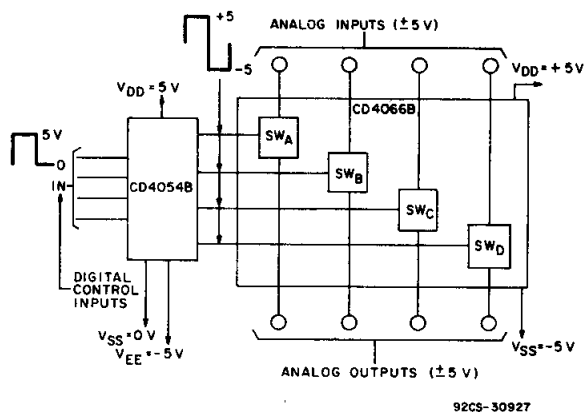
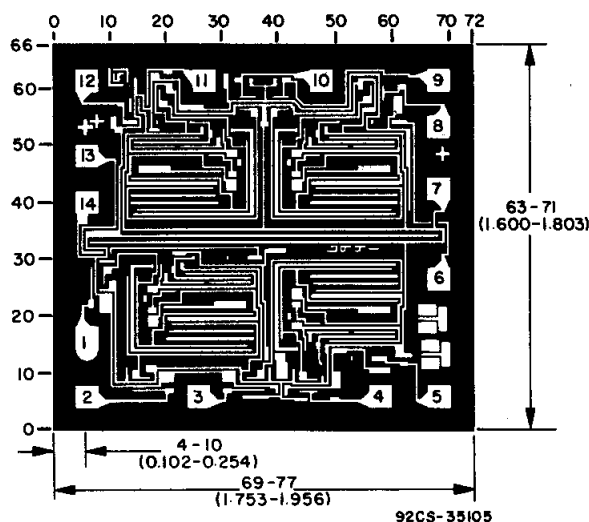


Fig. 18 — Bidirectional signal transmission via digital control logic.



### CD4066BH CHIP DIMENSIONS AND PAD LAYOUT

Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils ( $10^{-3}$  inch).

#### SPECIAL CONSIDERATIONS — CD4066B

1. In applications that employ separate power sources to drive  $V_{DD}$  and the signal inputs, the  $V_{DD}$  current capability should exceed  $V_{DD}/R_L$  ( $R_L$  = effective external load of the four CD4066B bilateral switches). This provision avoids any permanent current flow or clamp action on the  $V_{DD}$  supply when power is applied or removed from the CD4066B.
2. In certain applications, the external load-resistor current may include both  $V_{DD}$  and signal-line components. To avoid drawing  $V_{DD}$  current when switch current flows into terminals 1, 4, 8, or 11, the voltage drop across the bidirectional switch must not exceed 0.8 volts (calculated from  $R_{ON}$  values shown).  
No  $V_{DD}$  current will flow through  $R_L$  if the switch current flows into terminals 2, 3, 9, or 10.

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